

[查询IR2121供应商](#)

捷多邦，专业PCB打样工厂，24小时加

急出货

Data Sheet No. PD-6.018D

International  
**IR** Rectifier

**IR2121**

## CURRENT LIMITING LOW SIDE DRIVER

### Features

- Gate drive supply range from 12 to 18V
- Undervoltage lockout
- Current detection and limiting loop to limit driven power transistor current
- Error lead indicates fault conditions and programs shutdown time
- Output in phase with input

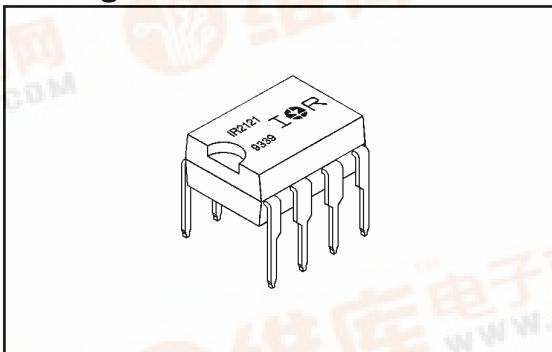
### Product Summary

$V_{OFFSET}$	5V max.
$I_{O+/-}$	1A / 2A
$V_{OUT}$	12 - 18V
$V_{CSth}$	230 mV
$t_{on/off}$ (typ.)	150 & 150 ns

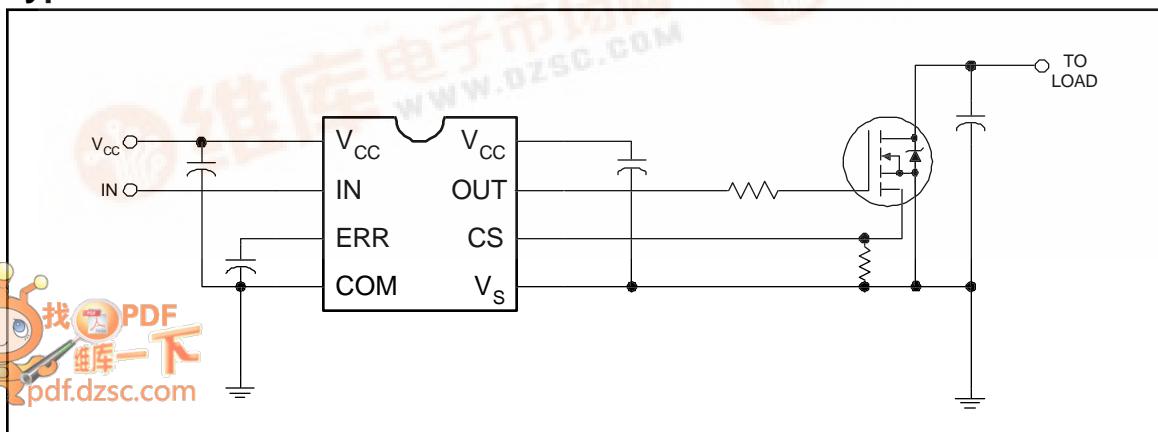
### Description

The IR2121 is a high speed power MOSFET and IGBT driver with over-current limiting protection circuitry. Latch immune CMOS technology enables ruggedized monolithic construction. Logic inputs are compatible with standard CMOS or LSTTL outputs. The output driver features a high pulse current buffer stage designed for minimum cross-conduction. The protection circuitry detects over-current in the driven power transistor and limits the gate drive voltage. Cycle-by-cycle shutdown is programmed by an external capacitor which directly controls the time interval between detection of the over-current limiting condition and latched shutdown. The output can be used to drive an N-channel power MOSFET or IGBT in the low side configuration.

### Package



### Typical Connection



## Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions.

Symbol	Parameter Definition	Value		Units
		Min.	Max.	
$V_{CC}$	Fixed Supply Voltage	-0.3	25	V
$V_S$	Gate Drive Return Voltage	$V_{CC} - 25$	$V_{CC} + 0.3$	
$V_O$	Output Voltage	$V_S - 0.3$	$V_{CC} + 0.3$	
$V_{IN}$	Logic Input Voltage	-0.3	$V_{CC} + 0.3$	
$V_{ERR}$	Error Signal Voltage	-0.3	$V_{CC} + 0.3$	
$V_{CS}$	Current Sense Voltage	$V_S - 0.3$	$V_{CC} + 0.3$	
$P_D$	Package Power Dissipation @ $T_A \leq +25^\circ\text{C}$	—	1.0	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	—	125	$^\circ\text{C}/\text{W}$
$T_J$	Junction Temperature	—	150	$^\circ\text{C}$
$T_S$	Storage Temperature	-55	150	
$T_L$	Lead Temperature (Soldering, 10 seconds)	—	300	

## Recommended Operating Conditions

The Input/Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. The  $V_S$  offset rating is tested with all supplies biased at 15V differential.

Symbol	Parameter Definition	Value		Units
		Min.	Max.	
$V_{CC}$	Fixed Supply Voltage	$V_S + 10$	$V_S + 20$	V
$V_S$	Gate Drive Return Voltage	-5	5	
$V_O$	Output Voltage	$V_S$	$V_{CC}$	
$V_{IN}$	Logic Input Voltage	0	$V_{CC}$	
$V_{ERR}$	Error Signal Voltage	0	$V_{CC}$	
$V_{CS}$	Current Sense Signal Voltage	$V_S$	$V_{CC}$	
$T_A$	Ambient Temperature	-40	125	$^\circ\text{C}$

## Dynamic Electrical Characteristics

$V_{BIAS} (V_{CC}) = 15V$ ,  $C_L = 3300 \text{ pF}$  and  $T_A = 25^\circ\text{C}$  unless otherwise specified. The dynamic electrical characteristics are defined in Figures 2 through 5.

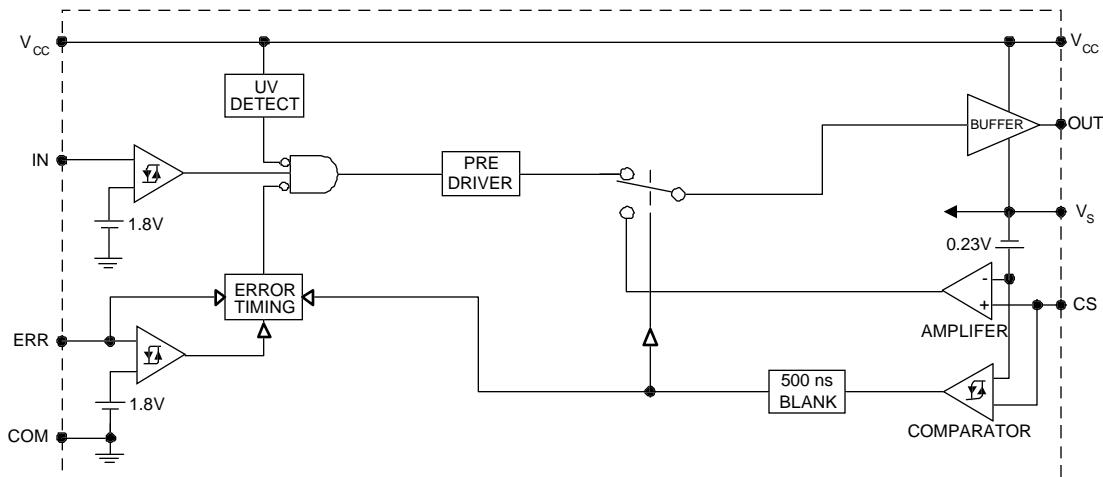
Symbol	Parameter Definition	Figure	Value			Units	Test Conditions
			Min.	Typ.	Max.		
$t_{on}$	Turn-On Propagation Delay	7	—	150	200	ns	
$t_{off}$	Turn-Off Propagation Delay	8	—	150	190		
$t_{sd}$	ERR Shutdown Propagation Delay	9	—	1.7	2.2	$\mu\text{s}$	
$t_r$	Turn-On Rise Time	10	—	43	60		
$t_f$	Turn-Off Fall Time	11	—	26	35	ns	
$t_{cs}$	CS Shutdown Propagation Delay	12	—	0.7	1.2		
$t_{err}$	CS to ERR Pull-Up Propagation Delay	13	—	9.0	12	$\mu\text{s}$	$C_{ERR} = 270 \text{ pF}$

## Static Electrical Characteristics

$V_{BIAS} (V_{CC}) = 15V$  and  $T_A = 25^\circ\text{C}$  unless otherwise specified. The  $V_{IN}$ ,  $V_{TH}$  and  $I_{IN}$  parameters are referenced to COM. The  $V_O$  and  $I_O$  parameters are referenced to  $V_S$ .

Symbol	Parameter Definition	Figure	Value			Units	Test Conditions
			Min.	Typ.	Max.		
$V_{IH}$	Logic “1” Input Voltage	14	2.2	—	—	V	$V_{CC} = 12\text{V}$ to $18\text{V}$
$V_{IL}$	Logic “0” Input Voltage	15	—	—	0.8		$V_{CC} = 12\text{V}$ to $18\text{V}$
$V_{CSTH+}$	CS Input Positive Going Threshold	16	150	230	320	mV	$V_{CC} = 12\text{V}$ to $18\text{V}$
$V_{CSTH-}$	CS Input Negative Going Threshold	17	130	200	260		$V_{CC} = 12\text{V}$ to $18\text{V}$
$V_{OH}$	High Level Output Voltage, $V_{BIAS} - V_O$	18	—	—	100		$I_O = 0\text{A}$
$V_{OL}$	Low Level Output Voltage, $V_O$	19	—	—	100		$I_O = 0\text{A}$
$I_{QCC}$	Quiescent VCC Supply Current	20	—	1.1	2.2	mA	$V_{IN} = V_{CS} = 0\text{V}$ or $5\text{V}$
$I_{IN+}$	Logic “1” Input Bias Current	21	—	4.5	10	$\mu\text{A}$	$V_{IN} = 5\text{V}$
$I_{IN-}$	Logic “0” Input Bias Current	22	—	—	1.0		$V_{IN} = 0\text{V}$
$I_{CS+}$	“High” CS Bias Current	23	—	4.5	10		$V_{CS} = 3\text{V}$ or $5\text{V}$
$I_{CS-}$	“Low” CS Bias Current	24	—	—	1.0		$V_{CS} = 0\text{V}$
$V_{CCUV+}$	$V_{CC}$ Supply Undervoltage Positive Going Threshold	25	8.3	8.9	9.6	V	
$V_{CCUV-}$	$V_{CC}$ Supply Undervoltage Negative Going Threshold	26	7.3	8.0	8.7		
$I_{ERR}$	ERR Timing Charge Current	27	65	100	130	$\mu\text{A}$	$V_{IN} = 5\text{V}$ , $V_{CS} = 3\text{V}$ $ERR < V_{ERR+}$
$I_{ERR+}$	ERR Pull-Up Current	28	8.0	15	—	mA	$V_{IN} = 5\text{V}$ , $V_{CS} = 3\text{V}$ $ERR > V_{ERR+}$
$I_{ERR-}$	ERR Pull-Down Current	29	16	30	—		$V_{IN} = 0\text{V}$
$I_{O+}$	Output High Short Circuit Pulsed Current	30	1.0	1.6	—	A	$V_O = 0\text{V}$ , $V_{IN} = 5\text{V}$ $PW \leq 10 \mu\text{s}$
$I_{O-}$	Output Low Short Circuit Pulsed Current	31	2.0	3.3	—		$V_O = 15\text{V}$ , $V_{IN} = 0\text{V}$ $PW \leq 10 \mu\text{s}$

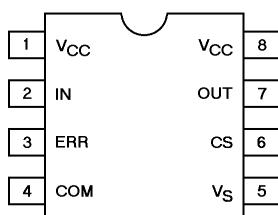
## Functional Block Diagram



## Lead Definitions

Lead Symbol	Description
V <sub>CC</sub>	Logic and gate drive supply
IN	Logic input for gate driver output (OUT), in phase with OUT
ERR	Serves multiple functions; status reporting, linear mode timing and cycle by cycle logic shutdown
COM	Logic ground
OUT	Gate drive output
V <sub>S</sub>	Gate drive supply return
CS	Current sense input to current sense comparator

## Lead Assignments

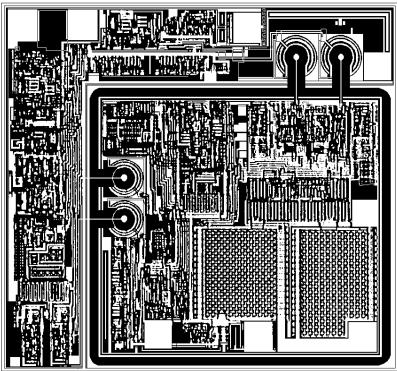


8 Lead DIP

IR2121

Part Number

**Device Information**

Process & Design Rule	HVDCMOS 4.0 $\mu$ m	
Transistor Count	410	
Die Size	104 X 111 X 26 (mil)	
Die Outline		
Thickness of Gate Oxide	800 $\text{\AA}$	
Connections	Material	Poly Silicon
First Layer	Width	4 $\mu$ m
	Spacing	6 $\mu$ m
	Thickness	5000 $\text{\AA}$
Second Layer	Material	Al - Si (Si: 1.0% $\pm$ 0.1%)
	Width	6 $\mu$ m
	Spacing	9 $\mu$ m
	Thickness	20,000 $\text{\AA}$
Contact Hole Dimension	8 $\mu$ m X 8 $\mu$ m	
Insulation Layer	Material	PSG ( $\text{SiO}_2$ )
	Thickness	1.5 $\mu$ m
Passivation (1)	Material	PSG ( $\text{SiO}_2$ )
	Thickness	1.5 $\mu$ m
Passivation (2)	Material	Proprietary*
	Thickness	Proprietary*
Method of Saw	Full Cut	
Method of Die Bond	Ablebond 84 - 1	
Wire Bond	Method	Thermo Sonic
	Material	Au (1.0 mil / 1.3 mil)
Leadframe	Material	Cu
	Die Area	Ag
	Lead Plating	Pb : Sn (37 : 63)
Package	Types	8 Lead PDIP
	Materials	EME6300 / MP150 / MP190
Remarks:	* Patent Pending	

# IR2121

International  
**IR** Rectifier

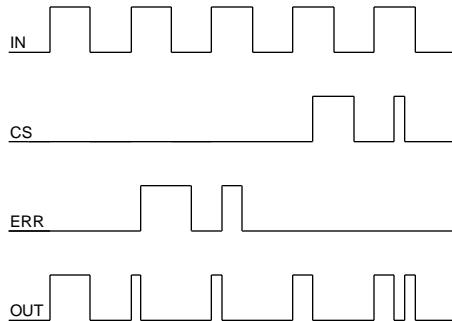


Figure 1. Input/Output Timing Diagram

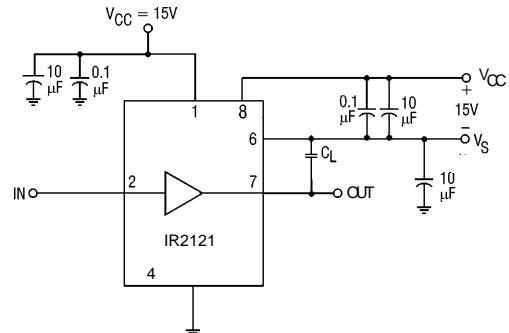


Figure 2. Switching Time Test Circuit

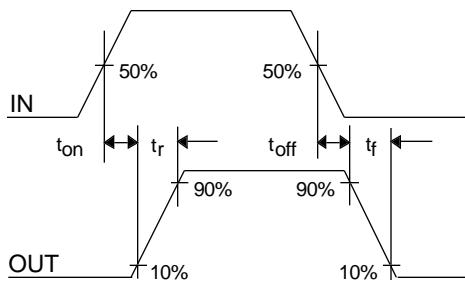


Figure 3. Switching Time Waveform Definitions

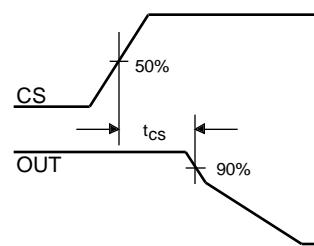


Figure 4. ERR Shutdown Waveform Definitions

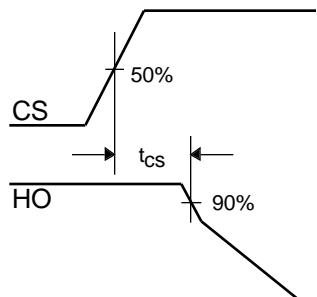


Figure 5. CS Shutdown Waveform Definitions

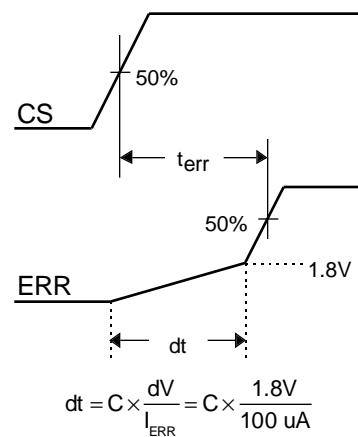
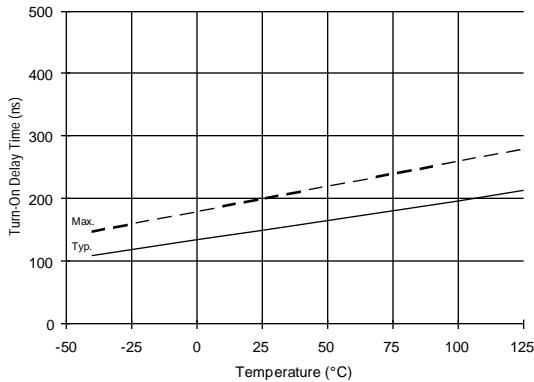
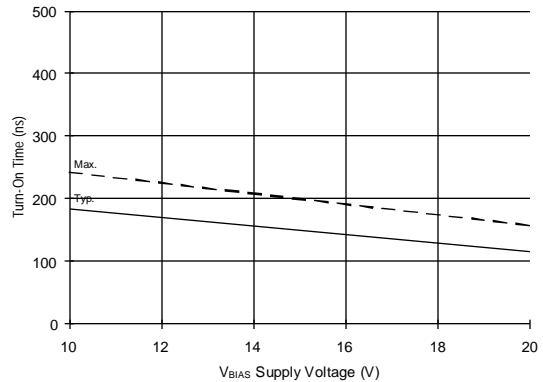


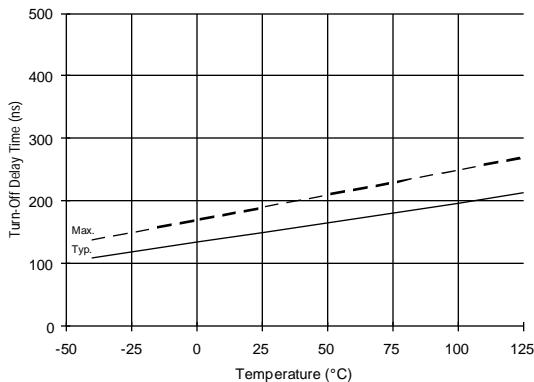
Figure 6. CS to ERR Waveform Definitions



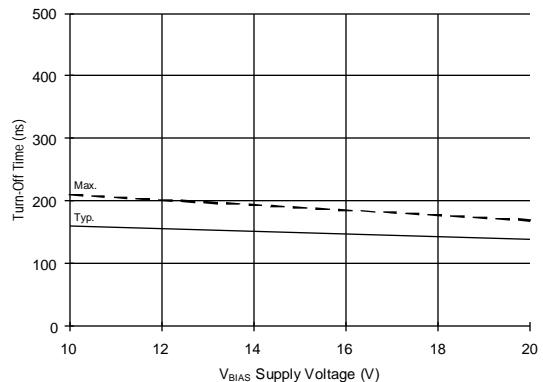
**Figure 7A. Turn-On Time vs. Temperature**



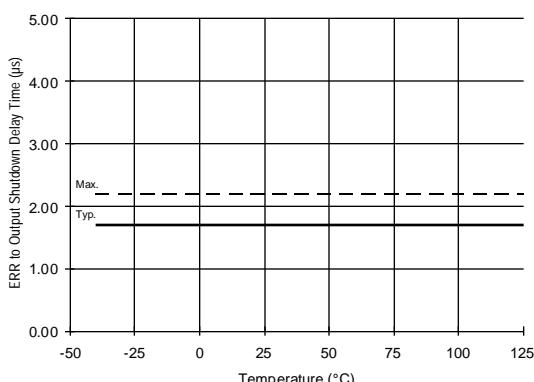
**Figure 7B. Turn-On Time vs. Voltage**



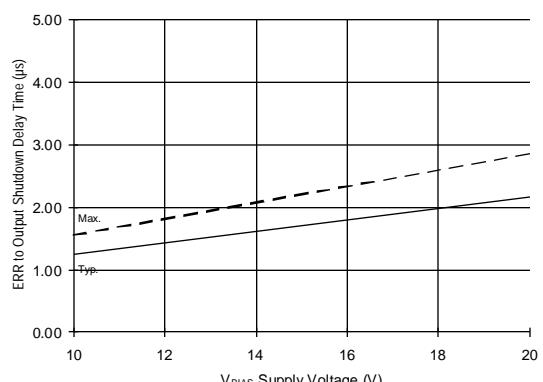
**Figure 8A. Turn-Off Time vs. Temperature**



**Figure 8B. Turn-Off Time vs. Voltage**



**Figure 9A. ERR to Output Shutdown vs. Temperature**



**Figure 9B. ERR to Output Shutdown vs. Voltage**

# IR2121

International  
**IR** Rectifier

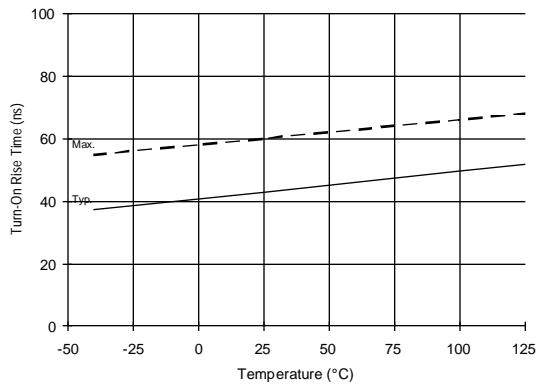


Figure 10A. Turn-On Rise Time vs. Temperature

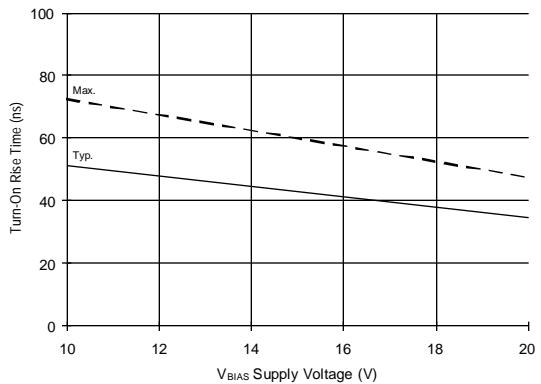


Figure 10B. Turn-On Rise Time vs. Voltage

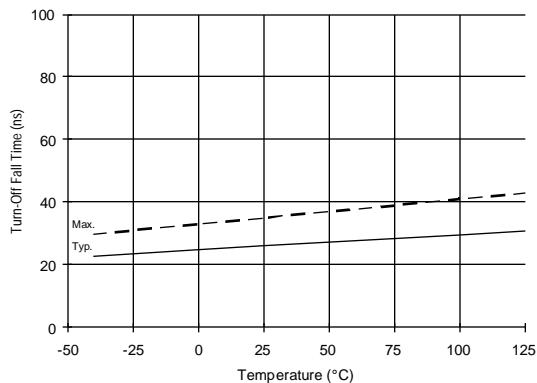


Figure 11A. Turn-Off Fall Time vs. Temperature

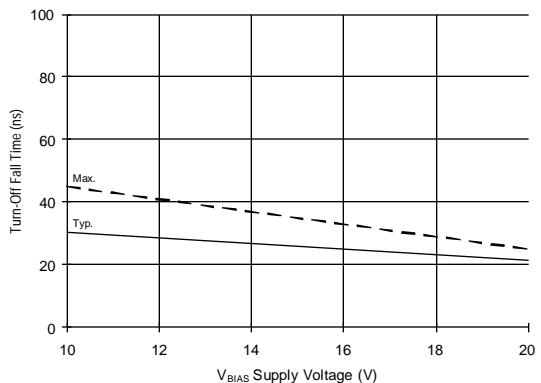


Figure 11B. Turn-Off Fall Time vs. Voltage

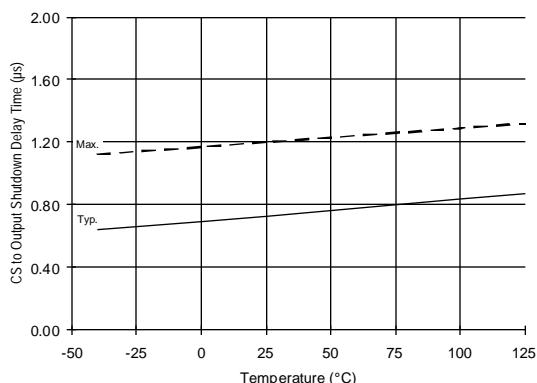


Figure 12A. CS to Output Shutdown vs. Temperature

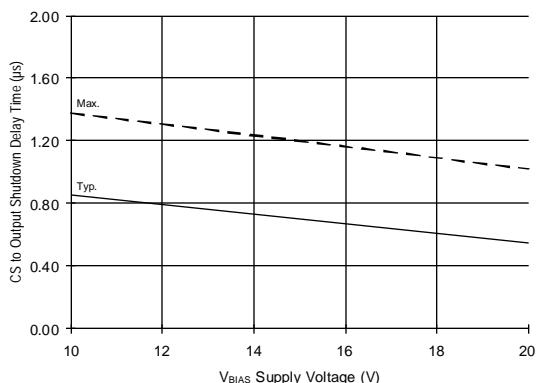


Figure 12B. CS to Output Shutdown vs. Voltage

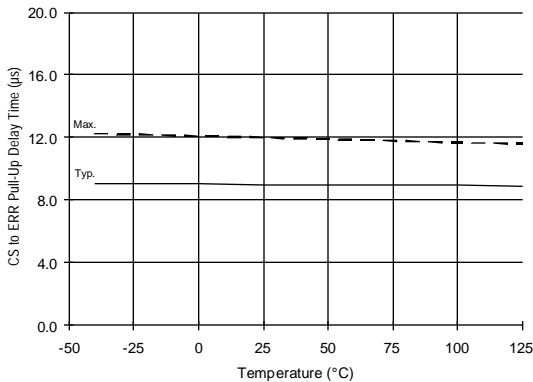


Figure 13A. CS to ERR Pull-Up vs. Temperature

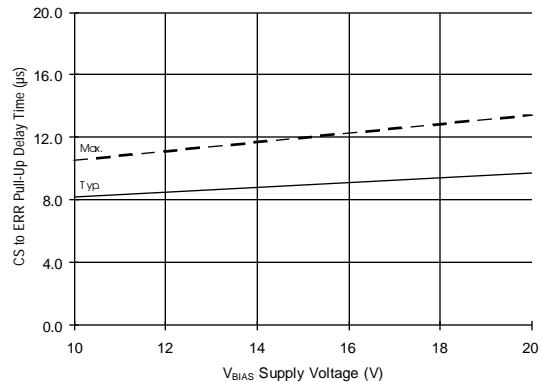


Figure 13B. CS to ERR Pull-Up vs. Voltage

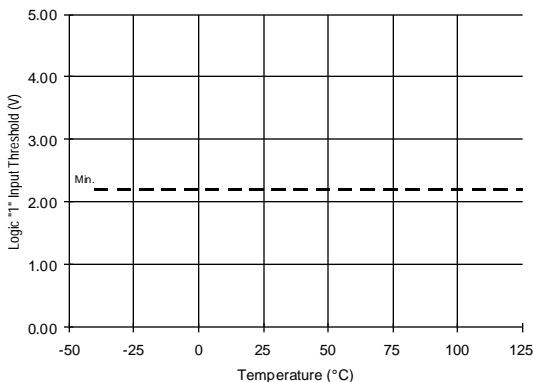


Figure 14A. Logic "1" Input Threshold vs. Temperature

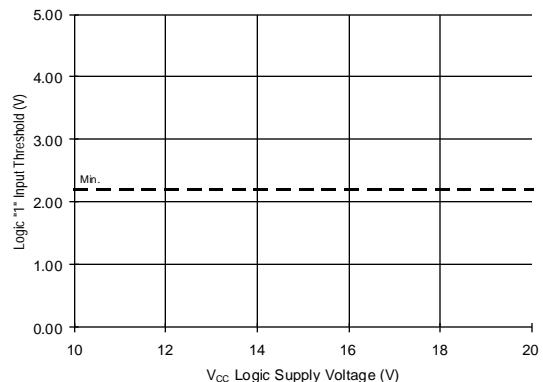


Figure 14B. Logic "1" Input Threshold vs. Voltage

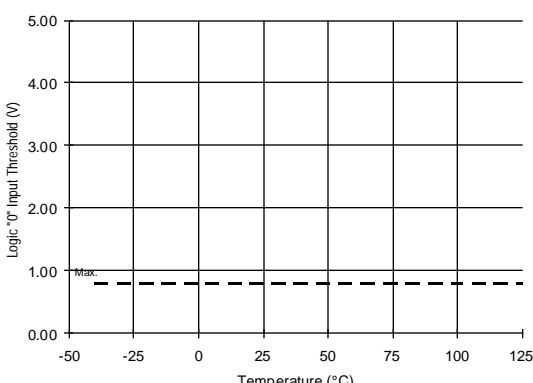


Figure 15A. Logic "0" Input Threshold vs. Temperature

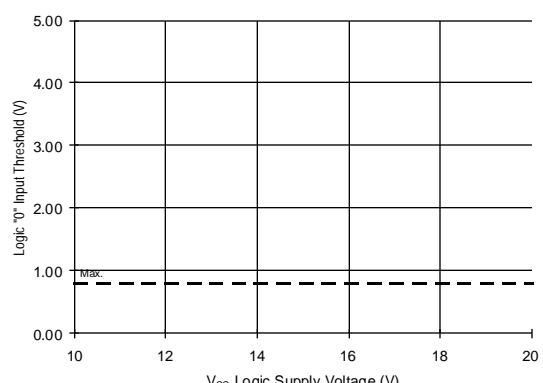


Figure 15B. Logic "0" Input Threshold vs. Voltage

# IR2121

International  
**IR** Rectifier

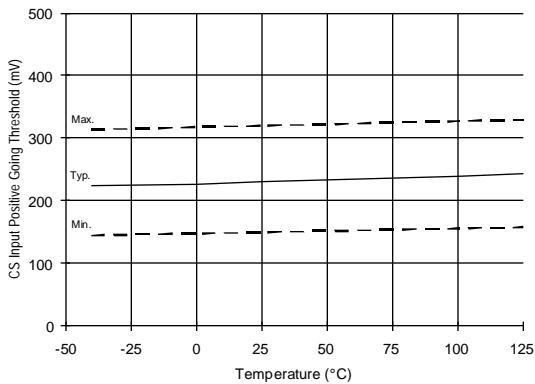


Figure 16A. CS Input Threshold (+) vs. Temperature

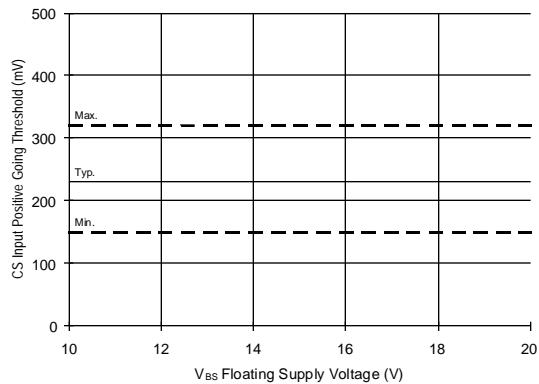


Figure 16B. CS Input Threshold (+) vs. Voltage

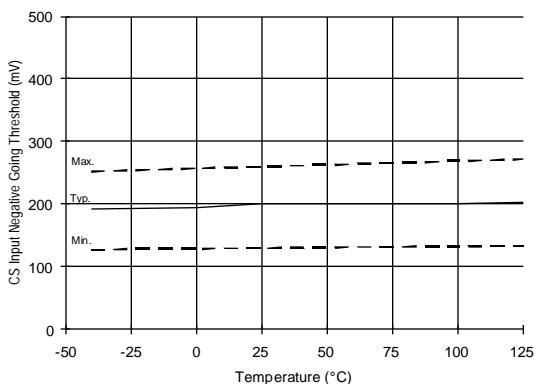


Figure 17A. CS Input Threshold (-) vs. Temperature

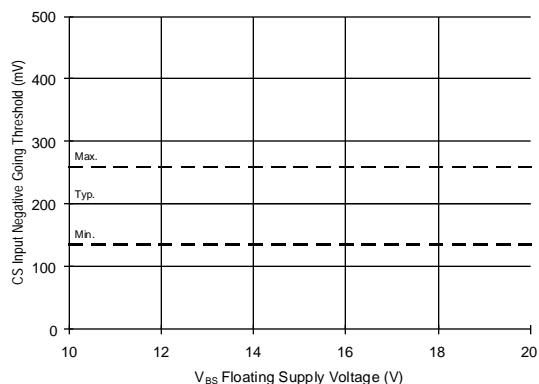


Figure 17B. CS Input Threshold (-) vs. Voltage

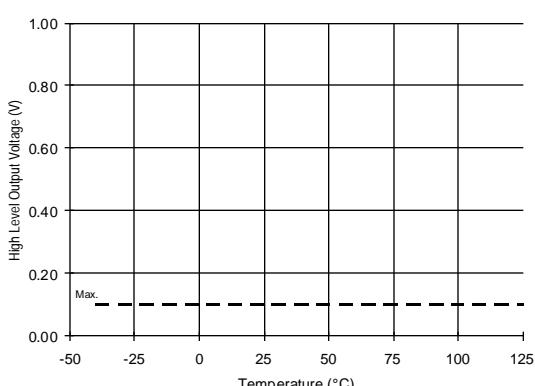


Figure 18A. High Level Output vs. Temperature

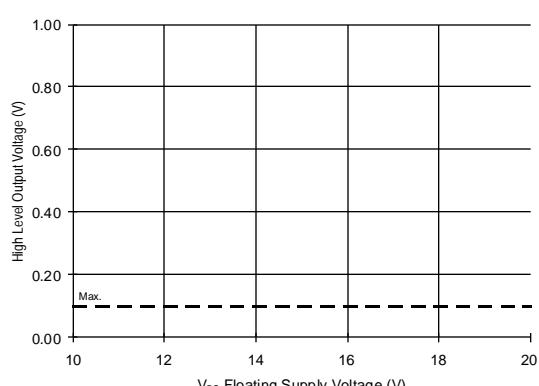


Figure 18B. High Level Output vs. Voltage

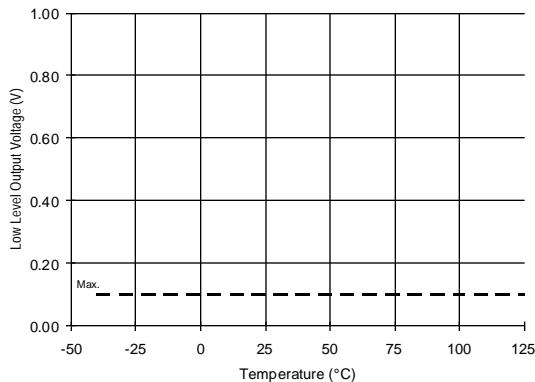


Figure 19A. Low Level Output vs. Temperature

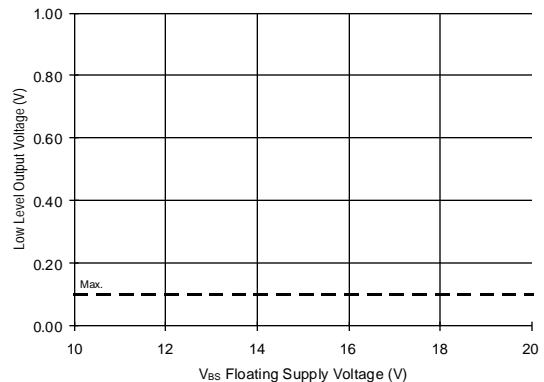


Figure 19B. Low Level Output vs. Voltage

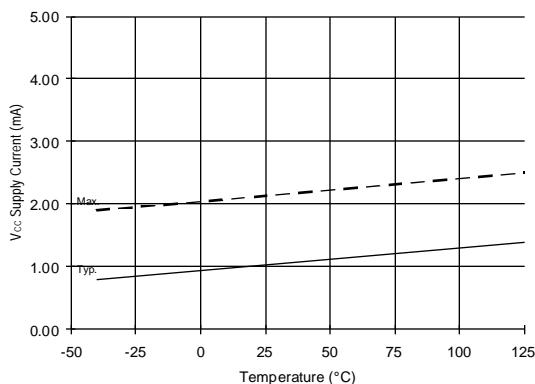


Figure 20A. V<sub>CC</sub> Supply Current vs. Temperature

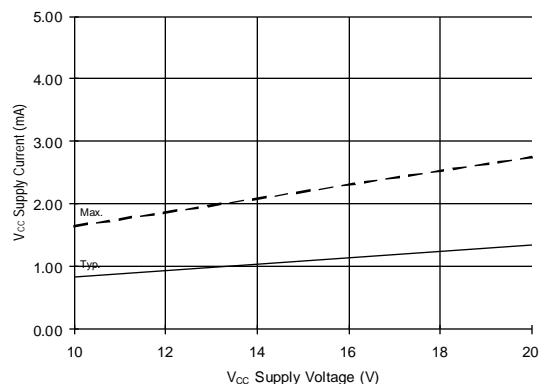


Figure 20B. V<sub>CC</sub> Supply Current vs. Voltage

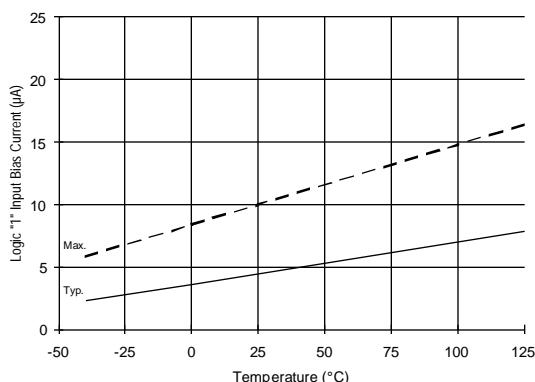


Figure 21A. Logic "1" Input Current vs. Temperature

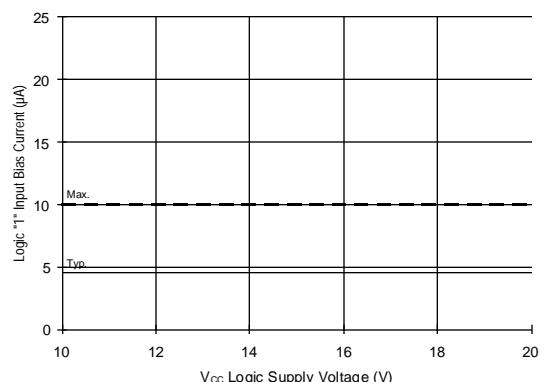


Figure 21B. Logic "1" Input Current vs. Voltage

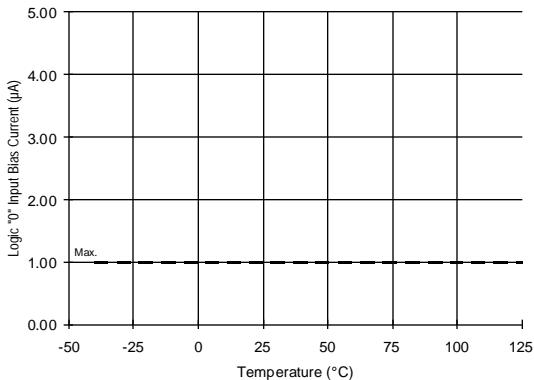


Figure 22A. Logic "0" Input Current vs. Temperature

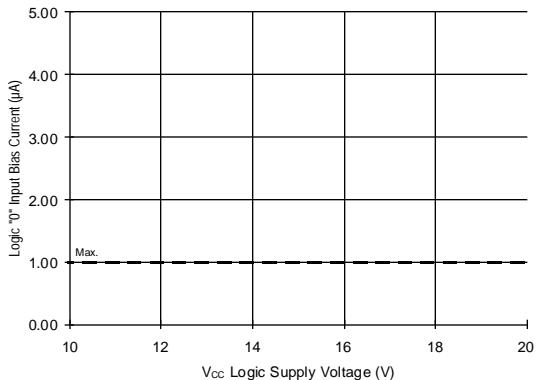


Figure 22B. Logic "0" Input Current vs. Voltage

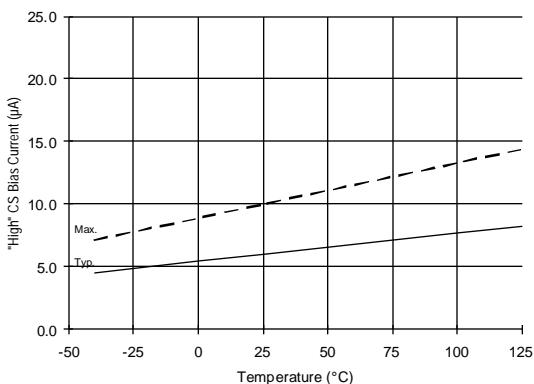


Figure 23A. "High" CS Bias Current vs. Temperature

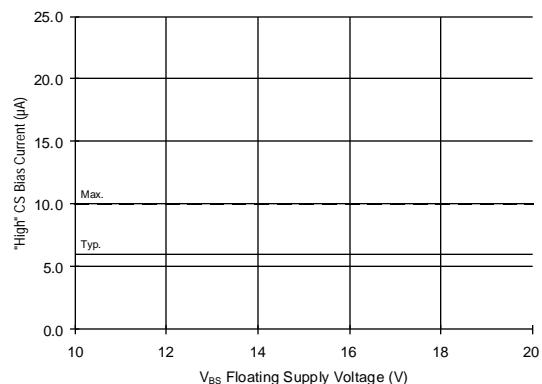


Figure 23B. "High" CS Bias Current vs. Voltage

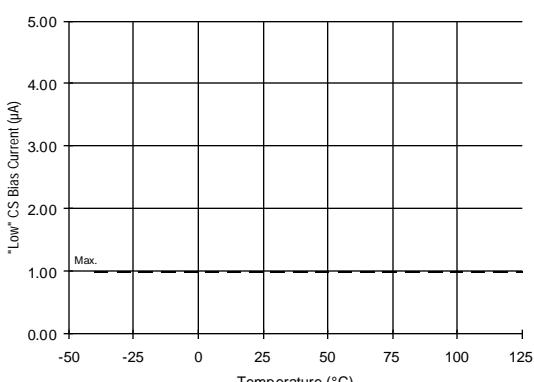


Figure 24A. "Low" CS Bias Current vs. Temperature

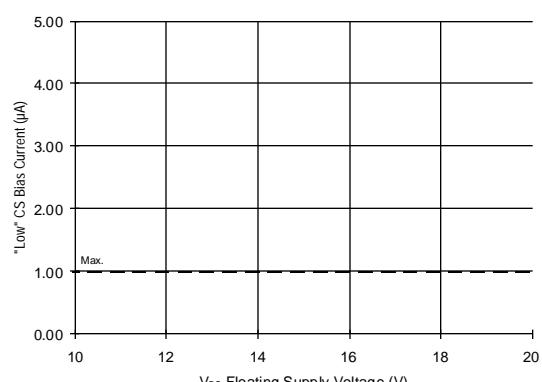


Figure 24B. "Low" CS Bias Current vs. Voltage

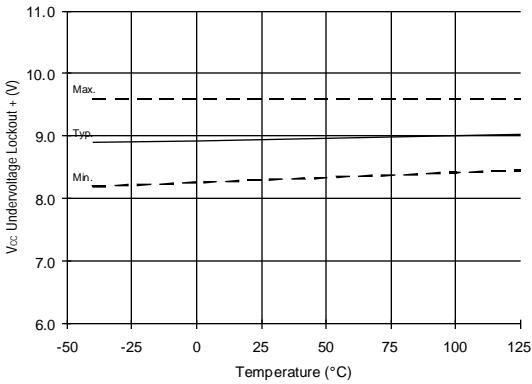


Figure 25. V<sub>CC</sub> Undervoltage (+) vs. Temperature

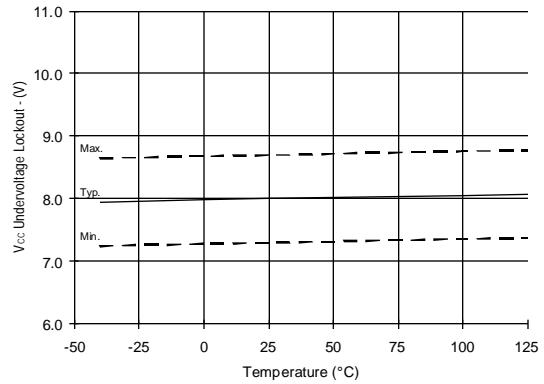


Figure 26. V<sub>CC</sub> Undervoltage (-) vs. Temperature

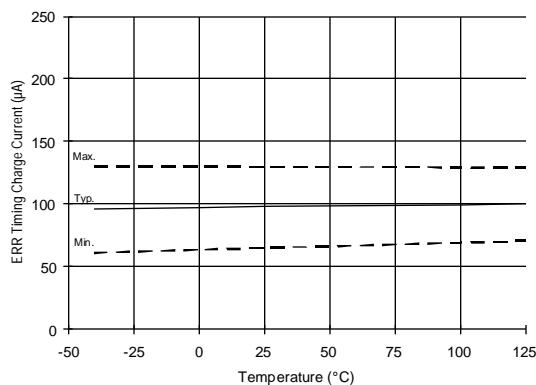


Figure 27A. ERR Timing Charge Current vs. Temperature

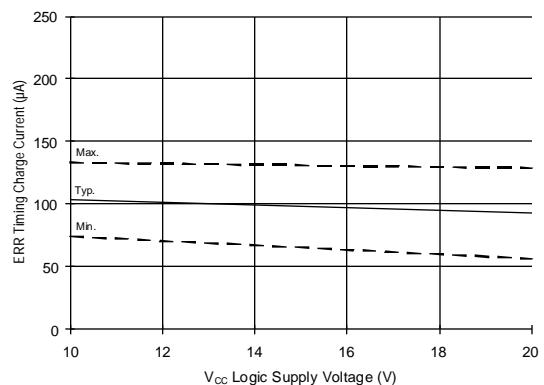


Figure 27B. ERR Timing Charge Current vs. Voltage

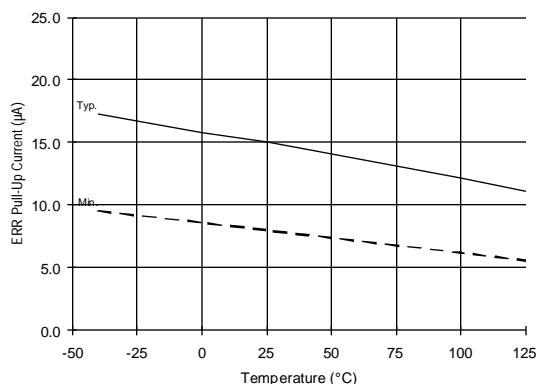


Figure 28A. ERR Pull-Up Current vs. Temperature

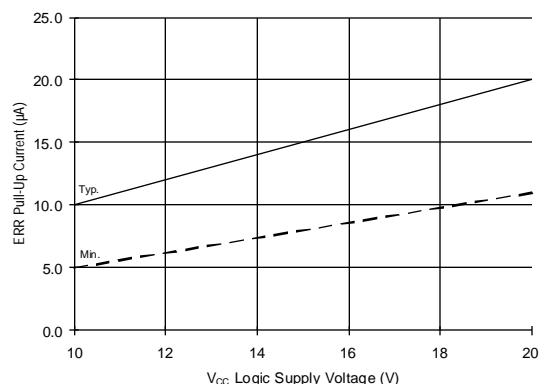


Figure 28B. ERR Pull-Up Current vs. Voltage

# IR2121

International  
**IR** Rectifier

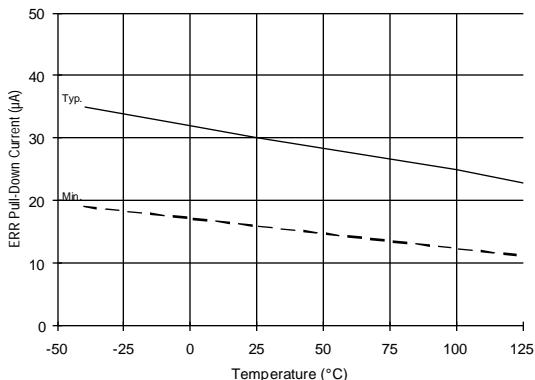


Figure 29A. ERR Pull-Down Current vs.Temperature

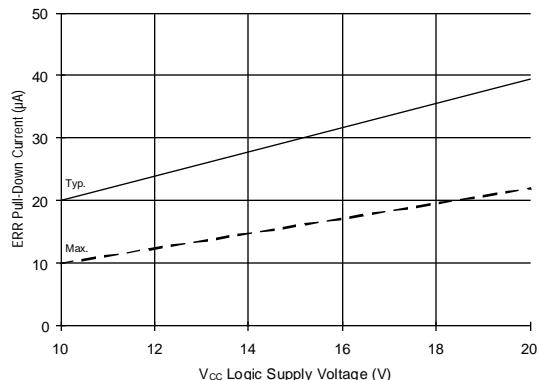


Figure 29B. ERR Pull-Down Current vs. Voltage

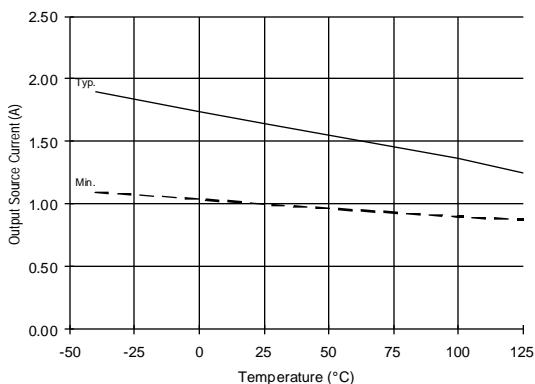


Figure 30A. Output Source Current vs.Temperature

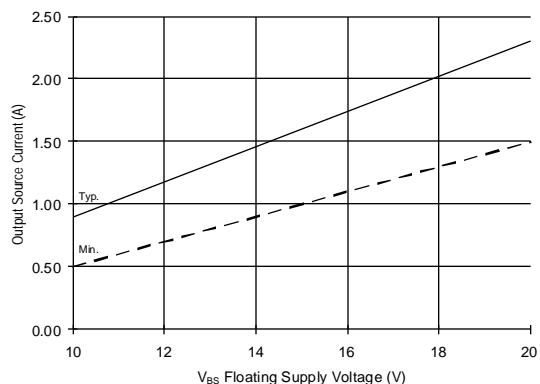


Figure 30B. Output Source Current vs. Voltage

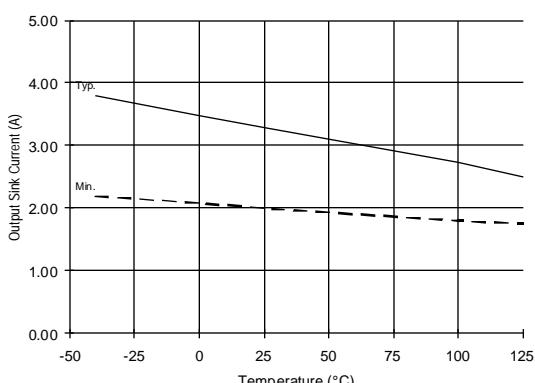


Figure 31A. Output Sink Current vs.Temperature

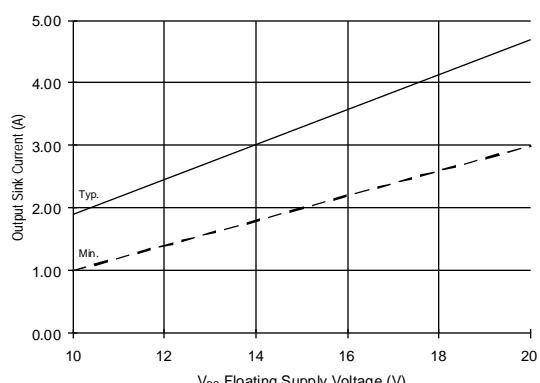


Figure 31B. Output Sink Current vs. Voltage

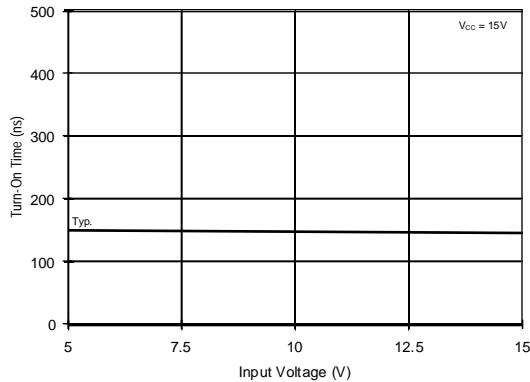


Figure 32A. Turn-On Time vs. Input Temperature

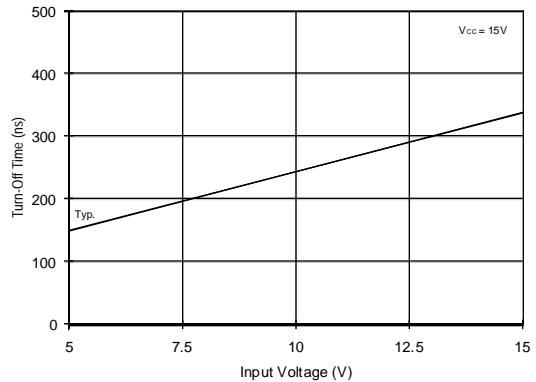


Figure 32B. Turn-Off Time vs. Input Voltage

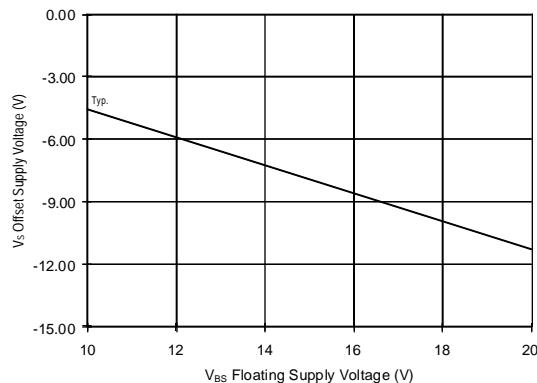


Figure 33. Maximum V<sub>S</sub> Negative Offset vs. Supply Voltage